



J3-J10: THROUGH HOLE SOLDER PADS
 Q1-Q2 HEAT SINK: 530714B00000G
 Q1-Q2 THERMAL PAD: 53-78-1ACG

TITLE
Dual Mosfet On-Off Switch
 DESIGN AND ENGINEERING
 Marcos Buydid

DATE 4/27/23
 Thursday, April 27, 2023
 SCALE NONE
 Sheet: 1/1 REV: A